

Multilayer Ceramic Chip Capacitors

CGA6P1X7S0J336M250AC









TDK item description CGA6P1X7S0J336MT****

Applications	Automotive Grade	
Feature	General General (Up to 50V) AEC-Q200 AEC-Q200	
Series	CGA6(3225) [EIA 1210]	
Status	Production	



	Size	
Length(L)	3.20mm ±0.40mm	
Width(W)	2.50mm ±0.30mm	
Thickness(T)	2.50mm ±0.30mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	2.00mm to 2.40mm	
Recommended Land Pattern (PB)	1.00mm to 1.20mm	
Recommended Land Pattern (PC)	1.90mm to 2.50mm	

Electrical Characteristics		
Capacitance	33μF ±20%	
Rated Voltage	6.3VDC	
Temperature Characteristic	X7S(±22%)	
Dissipation Factor (Max.)	7.5%	
Insulation Resistance (Min.)	3ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

CGA6P1X7S0J336M250AC

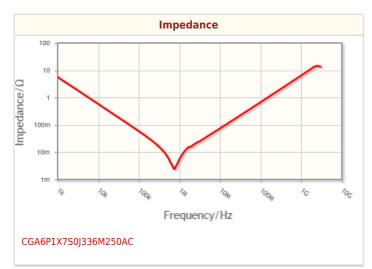


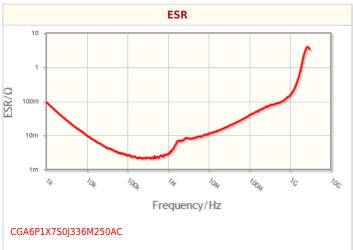


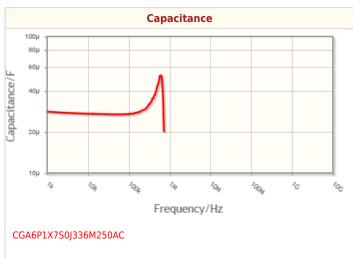


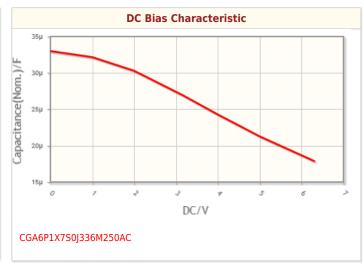


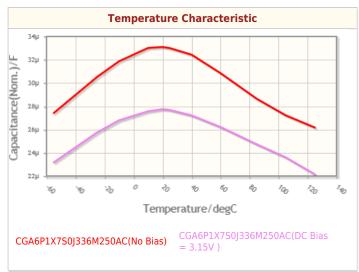
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

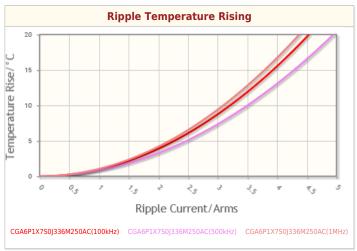












[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

CGA6P1X7S0J336M250AC

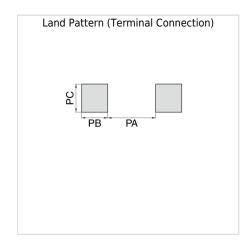








Associated Images



[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.